©	<b>Iaterial Composit</b> Copyright 2005. IPC, I tternational and Pan-An	Bannockb	urn, Illinois. A	Il rights reserved nations.	under both	This docum level parts,	ent is a declarat	ion of the succession of the s	ubstances s all lowe	within the ma r level materia	nufacture lls for wh	er listed iter iich the mar	n. Note: iufacture	if the item is an as er has engineering	sembly with low responsibility.
	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				e *	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					als and Mfg Information				
Supplier Informatio	on														
Company name*			Company unique ID				Unique ID Authority					Response Date*			
onsemi												2024-05-02			
Contact Name			Title - Contact				Phone - Contact*					Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com			
Authorized Representative*			Title - Representative				Phone - Representative*					Email - Representative*			
Product-Env-Stewards			Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com			
Requester Ite	Requester Item Number Mfr Iten		m Number Mfr Item Name				Effective Date	te Version Manufacturing Site		Site	We	eight*	UOM	Unit Type	
		NSBA124XF3T5G PN		PNP Digital Transistor (BRT)		2024-05-02				0.4	5	mg	Each		
Ianufacturing Pro	ccess Information	l													
Terminal Plating / Grid Array Material Terminal Bas			erminal Base	Alloy J-STD-020 MSL Rating Po			Peak Proc	Peak Process Body Temperature Max Time at Peak			Temperature Number of Reflow Cycles				
Matte Tin (Sn) - annealed		CU Alloy	Alloy 1			<b>260</b> C		С	30 seco		seconds	seconds 3			
omments															
vel 1 - maximum time	at peak temperature d	luring sol	dering is 10-3	0 seconds											
or more information re	egarding material com	position 1	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth	
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the
Supplier Digital Signature Ra	stislav Drska	Le			

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless	otherwise noted).				-	-		-
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.03	mg	Supplier	Silicon (Si)	7440-21-3		0.03	mg
Lead Frame	0.2	mg	Supplier	Silver (Ag)	7440-22-4		0.0356	mg
			В	Nickel (Ni)	7440-02-0		0.0618	mg
			Supplier	Iron (Fe)	7439-89-6		0.0854	mg
			Supplier	Copper (Cu)	7440-50-8		0.0172	mg
Mold Compound-Black	0.19	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.019	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0009	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.0275	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		0.1235	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.019	mg
Plating	0.02	mg	Supplier	Tin (Sn)	7440-31-5		0.02	mg
Wire Bond - Cu	0.01	mg	Supplier	Copper (Cu)	7440-50-8		0.01	mg